

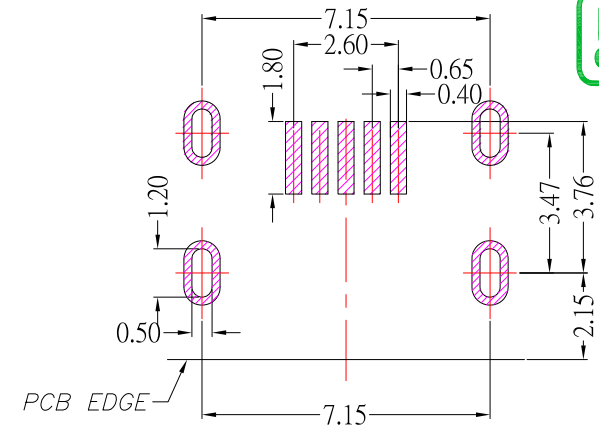
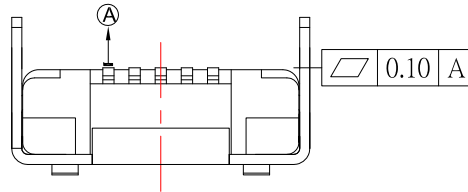


MRUSB-5B-D17xx-S347

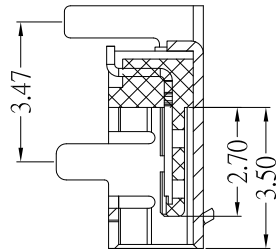
Shell Material : SHELL 鍍層:

Blank : BRASS
A : SUS

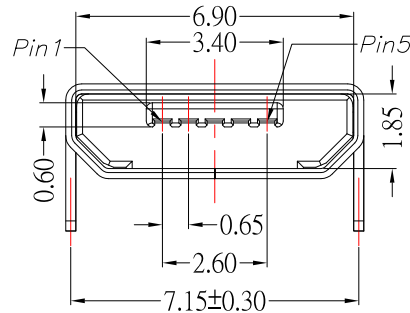
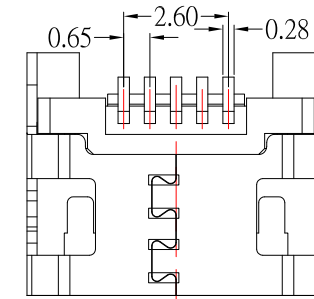
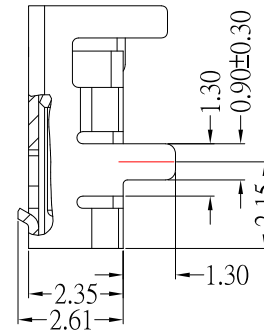
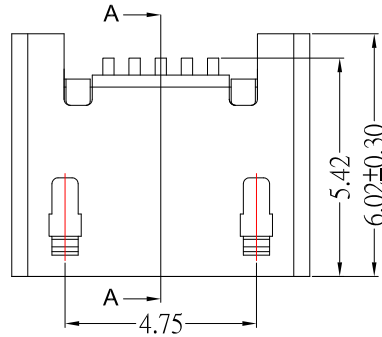
TN
NI



P.C.B LAYOUT MOUNTING PATTERN



SECTION A-A



NOTES:

1.MATERIAL:

- 1.1 HOUSING: LCP,UL94V-0
- 1.2 CONTACT: PHOSPHOR BRONZE
- 1.3 SHELL: BRASS / SUS

2.Finish:

- 2.1 Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.2 SHELL: NICKEL or TIN UNDER PLATED SURFACE LAYER

3.SPECIFICATION:

- 3.1 CURRENT RATING: 1.8 A Max(PIN1,5)
1.0 A Max(PIN2,3,4)
- 3.2 DIELECTRIC WITHSTANDING VOLTAGE: 100 V(ac) FOR 1min
- 3.3 CONTACT RESISTANCE: 30 mΩ MAX.
- 3.4 INSULATION RESISTANCE: 100 MΩ MIN.
- 3.5 TOTAL MATING FORCE: 3.57 KgF MAX.
- 3.6 TOTAL UNMATING FORCE: 1.0 KgF MIN.
- 3.7 TEMPERATURE RANGE: -30℃ ~ +80℃

ITEM NO.	DESCRIPTION	DRAWN	DATE
4	更新樣式	Jack	021420
3	更新尺寸	Jack	031119
2	更新為A0版	Jack	052217
1	新增材質選項	Jack	051117

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5	±0.2
Above 5 ~ 15	±0.3
Above 15 ~ 30	±0.4
Above 30 ~ 50	±0.5
Angle	±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	02/14/20			
CHECKED BY:	DATE	FINISH	MODLE	MICRO USB 5BF 無捲邊 SHELLED DIP TYPE
Jacky Chen	02/14/20			
APPROVED BY:	DATE	SCALE	DWG NO.	SIZE
Tony Kao	02/14/20	1 : 1	MRUSB-5B-D17xx-S347	A4
		SHEET NO.	PART NO.	VER
		1 of 1	MRUSB-5B-D17xx-S347	R4